

# Update to IEEE on ODVA Liaison Activities

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# Activity Overview

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- Attended “ODVA 2017 Industry Conference” (every 18 months)
  - Proceedings: <https://www.odva.org/Happenings/Industry-Conference-and-Annual-Meeting-Library>
    - Papers on: Single-pair Ethernet and liaisons, 3cg, E2E links
- Presented IEEE update to the ODVA BOD
- Discussed 3cg use cases with select SIG chairs (SIG is like a TF)
- Process Automation is a key initiative
  - SIG meetings, papers, and the Keynote speech